

描述 / Descriptions

超快恢复二极管，反向电压：50V~600V，正向电流：2.0A，薄型 SOD-123FL 封装。

Surface Mount Superfast Recovery Rectifiers, Reverse Voltage: 50 to 600V, Forward Current: 2.0A, SOD-123FL thin package.

特征 / Features

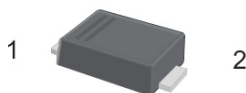
高效率，超快恢复时间，无铅符合欧盟 RoHS 指令 2011/65/EU，适用于表面贴装。无卤产品。

Superfast recovery times for high efficiency, Lead free in comply with EU RoHS 2011/65/EU directives, For surface mounted applications. Halogen free product.

用途 / Applications

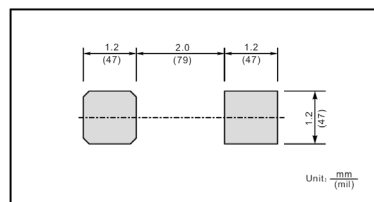
一般用途。

General purpose.

内部等效电路 / Equivalent Circuit**引脚排列 / Pinning**

PIN	DESCRIPTION
1	Cathode
2	Anode

The recommended mounting pad size

**印章代码 / Marking**

见印章说明。See Marking Instructions.

极限参数 / Absolute Maximum Ratings(Ta=25°C)

参数 Parameter	符号 Symbol	数值 Rating							单位 Unit
		ES2AW	ES2BW	ES2CW	ES2DW	ES2EW	ES2GW	ES2JW	
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	150	200	300	400	600	V
Maximum RMS voltage	V_{RMS}	35	70	105	140	210	280	420	V
Maximum DC Blocking Voltage	V_{DC}	50	100	150	200	300	400	600	V
Maximum Average Forward Rectified Current at $T_L = 100^\circ\text{C}$	$I_{F(AV)}$	2.0							A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I_{FSM}	50							A
Typical Junction Capacitance at $V_R=4V$, $f=1\text{MHz}$	C_j	25							pF
Typical Thermal Resistance ¹⁾	$R_{\theta JA}$	90							$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_j, T_{stg}	$-55\sim+150$							$^\circ\text{C}$

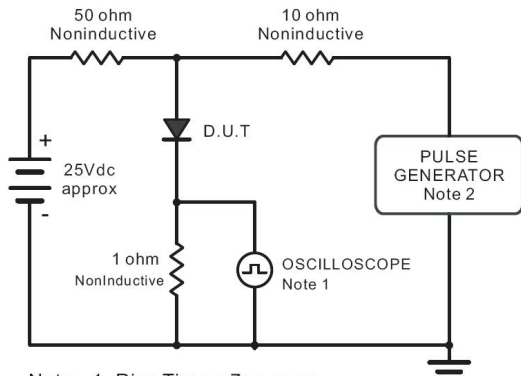
Note:

1) P.C.B. mounted with 0.2 X 0.2" (5 X 5 mm) copper pad areas.

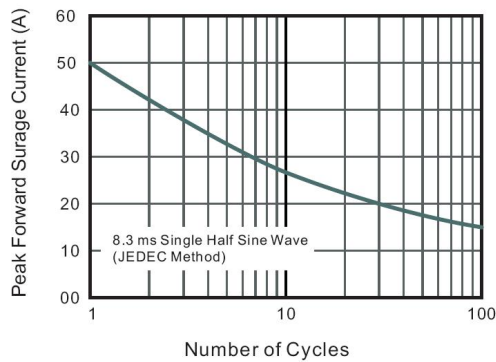
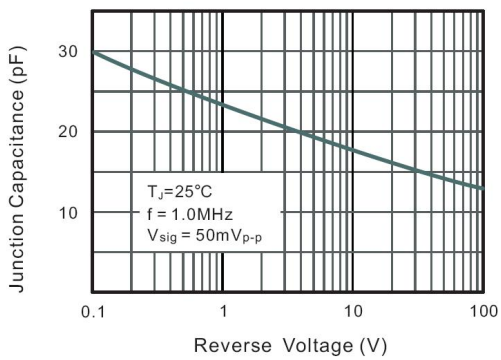
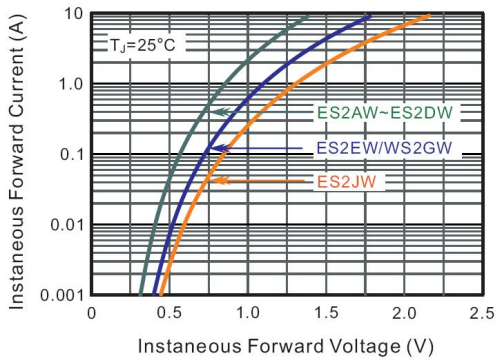
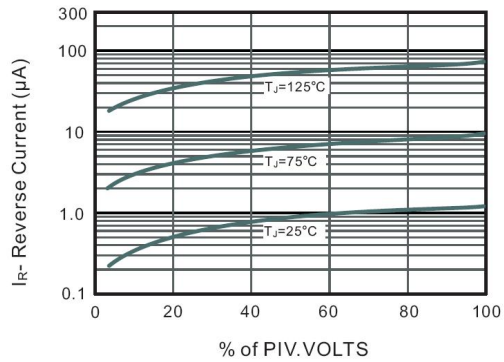
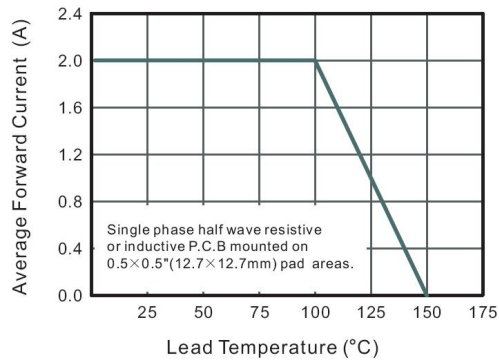
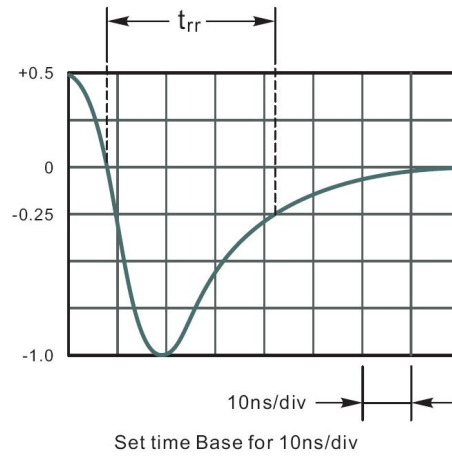
电性能参数 / Electrical Characteristics(Ta=25°C)

参数 Parameter	符号 Symbol	测试条件 Test Conditions	数值 Rating							单位 Unit
			ES2AW	ES2BW	ES2CW	ES2DW	ES2EW	ES2GW	ES2JW	
Maximum Forward Voltage	V _F	I _F =2.0A	1.0				1.25		1.68	V
Maximum DC Reverse Current at Maximum DC Blocking Voltage	I _R	T _a =25℃	5.0							μA
		T _a =125℃	100							μA
Maximum Reverse Recovery Time	T _{rr}	I _F =0.5A I _R =1A I _{rr} =0.25A	35							ns

电参数曲线图 / Electrical Characteristic Curve

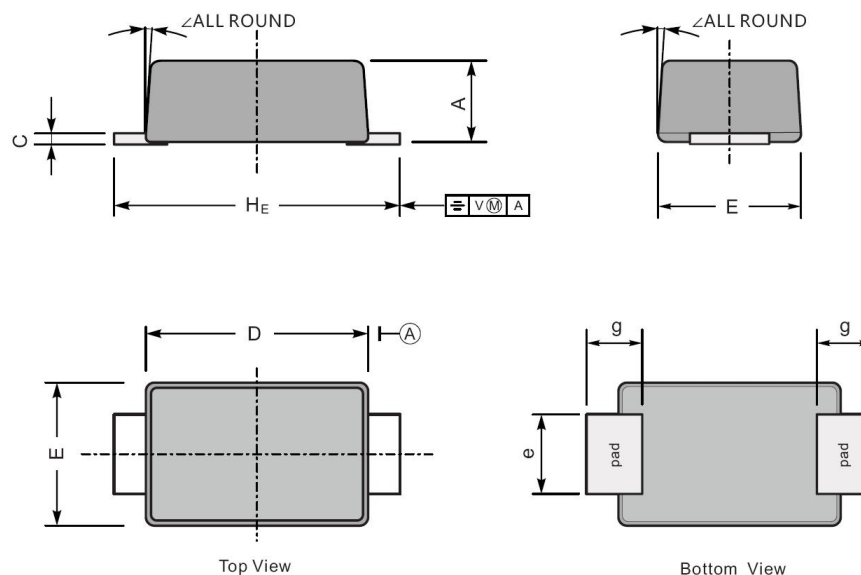


Note: 1. Rise Time = 7ns, max.
Input Impedance = 1megohm, 22pF.
2. Rise Time = 10ns, max.
Source Impedance = 50 ohms.



外形尺寸图 / Package Dimensions

SOD-123FL

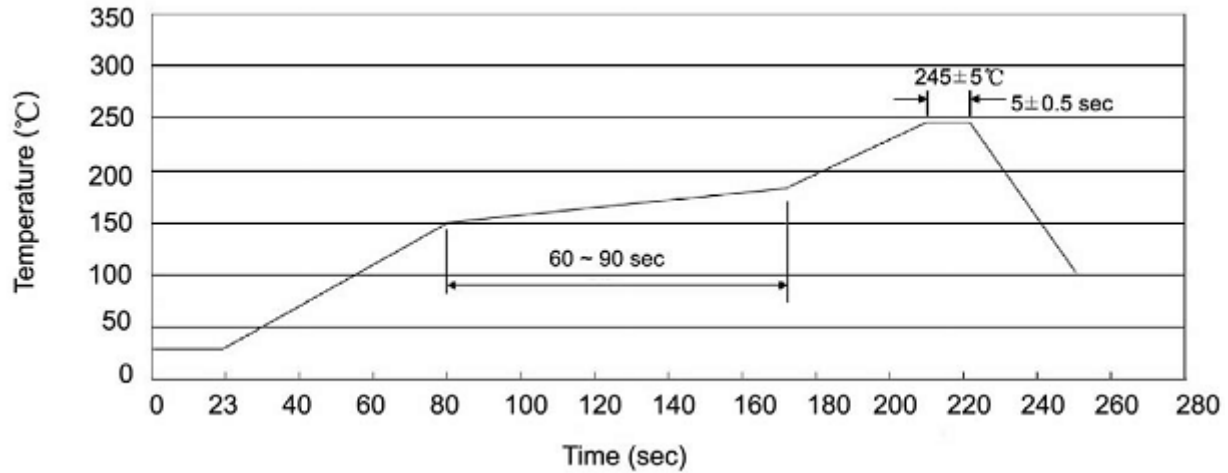


UNIT		A	C	D	E	e	g	H _E	∠
mm	max	1.1	0.20	2.9	1.9	1.1	0.9	3.8	7°
	min	0.9	0.12	2.6	1.7	0.8	0.7	3.5	
mil	max	43	7.9	114	75	43	35	150	
	min	35	4.7	102	67	31	28	138	

印章说明 / Marking Instructions

Marking

Type number	Marking code
ES2AW	E2L
ES2BW	
ES2CW	
ES2DW	
ES2EW	E2M
ES2GW	
ES2JW	E2H

回流焊温度曲线图(无铅) / Temperature Profile for IR Reflow Soldering(Pb-Free)


说明：

- 1、预热温度 25 ~ 150°C，时间 60 ~ 90sec;
- 2、峰值温度 245±5°C，时间持续为 5±0.5sec;
- 3、焊接制程冷却速度为 2 ~ 10°C/sec.

Note:

- 1.Preheating:25~150°C, Time:60~90sec.
- 2.Peak Temp.:245±5°C, Duration:5±0.5sec.
3. Cooling Speed: 2~10°C/sec.

耐焊接热试验条件 / Resistance to Soldering Heat Test Conditions

温度：260±5°C

时间：10±1 sec.

Temp.:260±5°C

Time:10±1 sec

包装规格 / Packaging SPEC.

卷盘包装 / REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOD-123FL	3000	8	24000	5	120000	7" ×11	185X180X105	550X210X220

使用说明 / Notices